IRFI720G

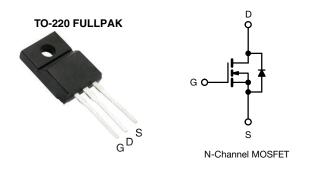
RoHS

COMPLIANT

Vishay Siliconix



Power MOSFET



PRODUCT SUMMA	RY	
V _{DS} (V)	400)
R _{DS(on)} (Ω)	$V_{GS} = 10 V$	1.8
Q _g max. (nC)	20	
Q _{gs} (nC)	3.3	
Q _{gd} (nC)	11	
Configuration	Sing	le

FEATURES

- Isolated package
- High voltage isolation = 2.5 kV_{RMS} (t = 60 s; f = 60 Hz)
- Sink to lead creepage distance = 4.8 mm
- Dynamic dV/dt rating
- · Low thermal resistance
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220 FULLPAK eliminates the need for additional insulating hardware in commercial-industrial applications. The molding compound used provides a high isolation capability and a low thermal resistance between the tab and external heatsink. This isolation is equivalent to using a 100 micron mica barrier with standard TO-220 product. The FULLPAK is mounted to a heatsink using a single clip or by a single screw fixing.

ORDERING INFORMATION	
Package	TO-220 FULLPAK
Lead (Pb)-free	IRFI720GPbF

ABSOLUTE MAXIMUM RATINGS (T _C PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	400		
Gate-source voltage			V _{GS}	± 20	- V	
Continuous durin coment	V	T _C = 25 °C		2.6		
Continuous drain current	V _{GS} at 10 V	$T_{C} = 25 \text{ °C}$ $T_{C} = 100 \text{ °C}$	ID	1.7	А	
Pulsed drain current ^a			I _{DM}	10		
Linear derating factor				0.24	W/°C	
Single pulse avalanche energy ^b			E _{AS}	150	mJ	
Repetitive avalanche current ^a			I _{AR}	2.6	А	
Repetitive avalanche energy ^a			mJ			
Maximum power dissipation	T _C =	25 °C	PD	30	W	
Peak diode recovery dV/dt ^c			dV/dt	4.0	V/ns	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150		
Soldering recommendations (peak temperature) ^d	For 10 s			300	°C	
Mounting torque	6.00 or 1	6-32 or M3 screw		10	lbf ∙ in	
Mounting torque	0-32 OF 1	VIS SCIEW		1.1	N·m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 38 mH, R_g = 25 Ω , I_{AS} = 2.6 A (see fig. 12)

c. $I_{SD} \le 3.3$ A, dI/dt ≤ 65 A/µs, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C

d. 1.6 mm from case

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PARAMETER	SYMBOL	TYP		MAX.			UNIT	
Maximum junction-to-ambient	R _{thJA}	- 65 - 4.1						
Maximum junction-to-case (drain)	R _{thJC}				°C/W			
	I.	•						
SPECIFICATIONS (T _J = 25 °C, u	nless otherw	rise noted)						
PARAMETER	SYMBOL	-		ONS	MIN.	TYP.	MAX.	UNIT
Static	0111202						in da	
Drain-ssource breakdown voltage	V _{DS}	Ves	= 0 V, I _D = 2	50 µA	400	_	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_J$		e to 25 °C,		-	0.51	-	V/°C
Gate-source threshold voltage	V _{GS(th)}		= V _{GS} , I _D = 2		2.0	-	4.0	V
Gate-source leakage	I _{GSS}		$V_{GS} = \pm 20$ V		-	-	± 100	nA
	¹ G55		= 400 V, V _{GS}		_	-	25	103
Zero gate voltage drain current	I _{DSS}			T _J = 125 °C	-	-	250	μA
Drain-source on-state resistance	R _{DS(on)}	$V_{DS} = 320$ V _{GS} = 10 V		= 1.6 A ^b	_	_	1.8	Ω
Forward transconductance	gfs		= 0 ⁻ = 50 V, I _D = 1		1.5	_	-	S
Dynamic	9ts	VDS -	- 50 V, I <u>D</u> = 1	.0 A	1.0			
Input capacitance	C _{iss}			-	410	_		
Output capacitance	C _{oss}	-	V _{GS} = 0 V, V _{DS} = 25 V,		_	120	-	-
Reverse transfer capacitance	C _{rss}	f = 1.0 MHz, see fig. 5		_	47	_	pF	
Drain to sink capacitance	C		f = 1.0 MHz		_	12	-	-
Total gate charge	Q _g			•	_	-	20	
Gate-source charge	Q _{gs}	V _{GS} = 10 V		A, V _{DS} = 320 V,	_	-	3.3	nC
Gate-drain charge	Q _{gs} Q _{gd}	VGS = 10 V	see fig	. 6 and 13 ^b	_	_	11	
Turn-on delay time					_	10	-	
Rise time	t _{d(on)}	- Vpp =	= 200 V, I _D =	3.3 A.	_	14	-	-
Turn-off delay time	t _r	$R_{g} = 18 \Omega, R_{D} = 56 \Omega,$		-	30	-	ns	
Fall time	t _{d(off)} t _f	-	see fig. 10 ^b)	_	13	_	-
		£ 1	Mil- onen	drain	- 1.2	13	- 7.3	Ω
Gate input resistance	Rg		MHz, open	urain	1.2	-	1.3	Ω
Internal drain inductance	L _D	Between 6 mm (0.25			-	4.5	-	
		package and center of die contact					nH	
Internal source inductance	Ls			-	7.5	-		
Drain-Source Body Diode Characteristic	s							
Continuous source-drain diode current	la	MOSFET sym	bol	- 1 ⁰	-	_	2.6	
Continuous source-drain diode current	I _S	showing the		_	_	2.0	A	
Pulsed diode forward current ^a	I _{SM}	p - n junction diode		-	-	10		
Body diode voltage	V _{SD}	T ₁ = 25 °C	, I _S = 2.6 A,	$V_{GS} = 0 V^{b}$	-	-	1.6	v
Body diode reverse recovery time	t _{rr}				-	300	600	ns
Body diode reverse recovery charge	Q _{rr}	T_J = 25 °C, I _F = 3.3 A, dI/dt = 100 A/µs ^b		-	1.5	3.0	μC	
Forward turn-on time	t _{on}	latain ain ta		s negligible (turn				

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width $\leq 300~\mu s;~duty~cycle \leq 2~\%$

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

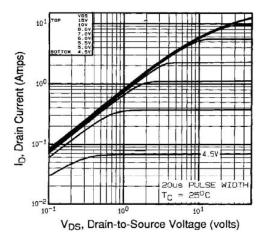


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

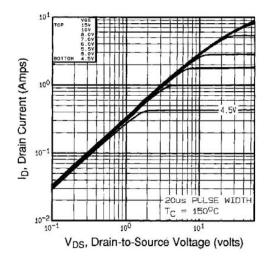


Fig. 2 - Typical Output Characteristics, $T_C = 150$ °C

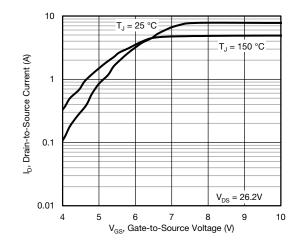


Fig. 3 - Typical Transfer Characteristics

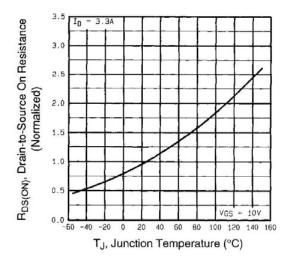


Fig. 4 - Normalized On-Resistance vs. Temperature



1000 0٧ 1MHz GS Cds SHORTED Cgs Cgd. 133 -Cad rss Cds -Cgd 800 OSS Capacitance (pF) 600 400 200 0 10⁰ 101 V_{DS}, Drain-to-Source Voltage (volts)

Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

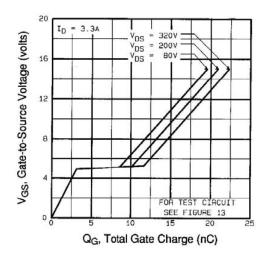
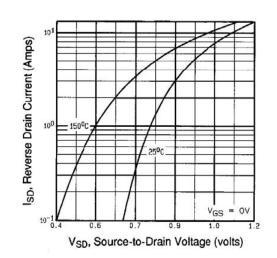


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage





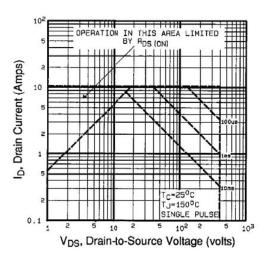


Fig. 8 - Maximum Safe Operating Area

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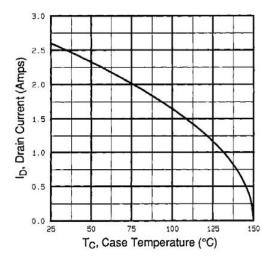


Fig. 9 - Maximum Drain Current vs. Case Temperature

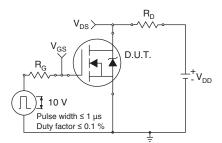


Fig. 10a - Switching Time Test Circuit

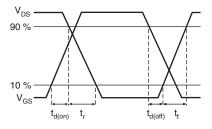
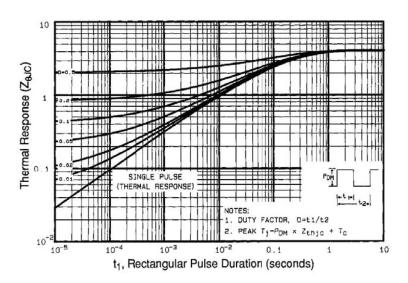


Fig. 10b - Switching Time Waveforms





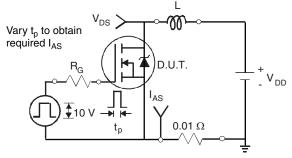
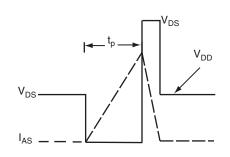
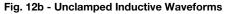


Fig. 12a - Unclamped Inductive Test Circuit





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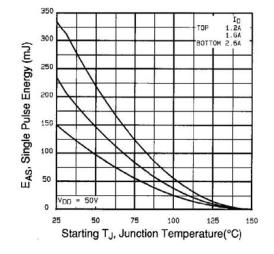


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

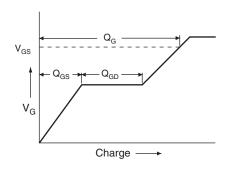


Fig. 13a - Basic Gate Charge Waveform

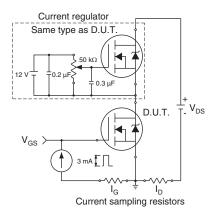
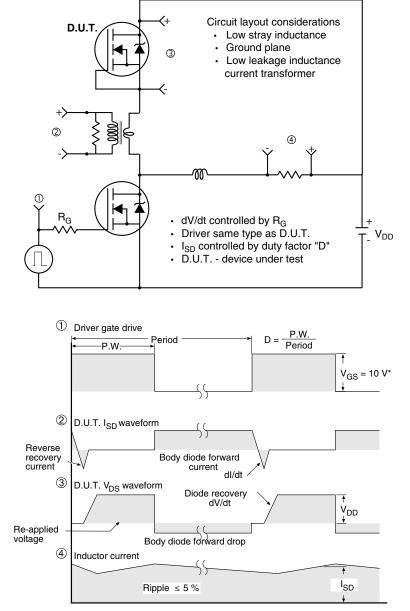


Fig. 13b - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit

* V_{GS} = 5 V for logic level devices and 3 V drive devices

Fig. 14 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?91152.



Vishay Siliconix

TO-220 FULLPAK (High Voltage)

OPTION 1: FACILITY CODE = 9



		MILLIMETERS	
DIM.	MIN.	NOM.	MAX.
A	4.60	4.70	4.80
b	0.70	0.80	0.91
b1	1.20	1.30	1.47
b2	1.10	1.20	1.30
С	0.45	0.50	0.63
D	15.80	15.87	15.97
е		2.54 BSC	
E	10.00	10.10	10.30
F	2.44	2.54	2.64
G	6.50	6.70	6.90
L	12.90	13.10	13.30
L1	3.13	3.23	3.33
Q	2.65	2.75	2.85
Q1	3.20	3.30	3.40
ØR	3.08	3.18	3.28

Notes

- 1. To be used only for process drawing
- 2. These dimensions apply to all TO-220 FULLPAK leadframe versions 3 leads
- 3. All critical dimensions should C meet $C_{pk} > 1.33$
- 4. All dimensions include burrs and plating thickness
- 5. No chipping or package damage
 6. Facility code will be the 1st character located at the 2nd row of the unit marking

1



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OPTION 2: FACILITY CODE = Y



	MILLIN	IETERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.570	4.830	0.180	0.190	
A1	2.570	2.830	0.101	0.111	
A2	2.510	2.850	0.099	0.112	
b	0.622	0.890	0.024	0.035	
b2	1.229	1.400	0.048	0.055	
b3	1.229	1.400	0.048	0.055	
С	0.440	0.629	0.017	0.025	
D	8.650	9.800	0.341	0.386	
d1	15.88	16.120	0.622	0.635	
d3	12.300	12.920	0.484	0.509	
E	10.360	10.630	0.408	0.419	
е	2.54	BSC	0.100) BSC	
L	13.200	13.730	0.520	0.541	
L1	3.100	3.500	0.122	0.138	
n	6.050	6.150	0.238	0.242	
ØP	3.050	3.450	0.120	0.136	
u	2.400	2.500	0.094	0.098	
V	0.400	0.500	0.016	0.020	

DWG: 5972

Notes

1. To be used only for process drawing

2. These dimensions apply to all TO-220 FULLPAK leadframe versions 3 leads

3. All critical dimensions should C meet $C_{pk} > 1.33$

4. All dimensions include burrs and plating thickness

5. No chipping or package damage
6. Facility code will be the 1st character located at the 2nd row of the unit marking

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